

Date: - 28 Mar, 2001

Data Sheet Issue:- 1

Phase Control Thyristor Types N1588NS200 to N1588NS260

Absolute Maximum Ratings

	VOLTAGE RATINGS		UNITS
V_{DRM}	Repetitive peak off-state voltage, (note 1)	2000-2600	V
V_{DSM}	Non-repetitive peak off-state voltage, (note 1)	2000-2600	V
V_{RRM}	Repetitive peak reverse voltage, (note 1)	2000-2600	V
V_{RSM}	Non-repetitive peak reverse voltage, (note 1)	2100-2700	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
I _{T(AV)}	Mean on-state current. T _{sink} =55°C, (note 2)	1588	Α
I _{T(AV)}	Mean on-state current. T _{sink} =85°C, (note 2)	1087	Α
I _{T(AV)}	Mean on-state current. T _{sink} =85°C, (note 3)	656	А
I _{T(RMS)}	Nominal RMS on-state current. T _{sink} =25°C, (note 2)	3138	Α
I _{T(d.c.)}	D.C. on-state current. T _{sink} =25°C, (note 4)	2710	Α
I _{TSM}	Peak non-repetitive surge t _p =10ms, V _{RM} =0.6V _{RRM} , (note 5)	22.5	kA
I _{TSM2}	Peak non-repetitive surge t _p =10ms, V _{RM} ≤10V, (note 5)	24.75	kA
l ² t	I^2 t capacity for fusing t_p =10ms, V_{RM} =0.6 V_{RRM} , (note 5)	2.53×10 ⁶	A ² s
l ² t	I ² t capacity for fusing t _p =10ms, V _{RM} ≤10V, (note 5)	3.06×10 ⁶	A ² s
d: /d+	Maximum rate of rise of on-state current (repetitive), (Note 6)	150	A/µs
di _⊤ /dt	Maximum rate of rise of on-state current (non-repetitive), (Note 6)	300	A/µs
V_{RGM}	Peak reverse gate voltage	5	V
P _{G(AV)}	Mean forward gate power	2	W
P _{GM}	Peak forward gate power	30	W
V_{GD}	Non-trigger gate voltage, (Note 7)	0.25	V
T _{HS}	Operating temperature range	-40 to +125	°C
T _{stg}	Storage temperature range	-40 to +150	°C

Notes:

- 1) De-rating factor of 0.13% per °C is applicable for T_i below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, 125°C T_i initial.
- 6) V_D =67% V_{DRM} , I_{TM} =3000A, I_{FG} =2A, t_r ≤0.5 μ s, T_{case} =125°C.
- 7) Rated V_{DRM}.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS	
V _{TM}	Maximum peak on-state voltage	-	-	1.65	I _{TM} =2550A	V	
V_0	Threshold voltage	-	-	0.951		V	
rs	Slope resistance	-	-	0.268		mΩ	
dv/dt	Critical rate of rise of off-state voltage	1000	-	-	V _D =80% V _{DRM} , linear ramp	V/µs	
I _{DRM}	Peak off-state current	-	-	10	Rated V _{DRM} , T _{case} =25°C	mA	
I_{RRM}	Peak reverse current	-	-	10	Rated V _{RRM} , T _{case} =25°C	mA	
I _{DRM}	Peak off-state current	-	-	100	Rated V _{DRM}	mA	
I_{RRM}	Peak reverse current	-	-	100	Rated V _{RRM}	mA	
V _{GT}	Gate trigger voltage	-	-	3.0	T 25°C V 40V L 24	V	
lgт	Gate trigger current	-	-	300	$T_{j}=25$ °C, $V_{D}=10V$, $I_{T}=2A$	mA	
I _H	Holding current	-	-	1000	T _j =25°C	mA	
t _{gd}	Gate controlled turn-on delay time	-	0.5	1.5	IFG=2A, tr=0.5µs, VD=80%VDRM,	μs	
t _{gt}	Turn-on time	-	1.3	2.5	I _{TM} =2000A, di/dt=10A/μs, T _j =25°C		
Q _{rr}	Recovered Charge	-	4100	-		μC	
Q _{ra}	Recovered Charge, 50% chord	-	2400	2530	40004 + 4222 45/44 404/22 1/ 501/	μC	
I _{rm}	Reverse recovery current	-	155	-	I_{TM} =1000A, t_p =1ms, di/dt=10A/ μ s, V_r =50V	Α	
t _{rr}	Reverse recovery time, 50% chord	-	31	-		μs	
4	Turn-off time	-	1	350	I_{TM} =1000A, t_p =1ms, di/dt=10A/ μ s, V_r =50V, V_{dr} =80% V_{DRM} , dV_{dr} /dt=20V/ μ s		
tq	Turr-on time	ı	1	530	I_{TM} =1000A, t_p =1ms, di/dt =10A/ μ s, V_r =50V, V_{dr} =80% V_{DRM} , dV_{dr}/dt =200V/ μ s	— µs	
R_{θ}	Thermal resistance, junction to	-	-	0.022	Double side cooled	K/W	
θ	heatsink	-	-	0.044	Single side cooled	K/W	
F	Mounting force	19	-	26		kN	
W_t	Weight		510	-		g	

Notes: -

¹⁾ Unless otherwise indicated T_j=125°C.

Notes on Ratings and Characteristics

1.0 Voltage Grade Table

Voltage Grade	$V_{ m DRM} V_{ m DSM} V_{ m RRM} $	V _{RSM} V	V _D V _R DC V
20	2000	2100	1270
22	2200	2300	1380
24	2400	2500	1450
26	2600	2700	1550

2.0 Extension of Voltage Grades

This report is applicable to other and higher voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_i below 25°C.

4.0 Repetitive dv/dt

Standard dv/dt is 1000V/µs.

5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_0 + \sqrt{{V_0}^2 + 4 \cdot ff^2 \cdot r_s \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_s} \qquad W_{AV} = \frac{\Delta T}{R_{th}}$$
 and:
$$\Delta T = T_{j \max} - T_{Hs}$$

Where $V_0 = 0.951 \text{V}$, $r_s = 0.268 \text{m}\Omega$,

 R_{th} = Supplementary thermal impedance, see table below.

ff = Form factor, see table below.

Supplementary Thermal Impedance							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave Double Side Cooled 0.0312 0.0285 0.0267 0.0255 0.0240 0.0228 0.0220							
Square wave Single Side Cooled	0.0543	0.0513	0.0496	0.0484	0.0469	0.0455	0.0440
Sine wave Double Side Cooled	0.0256	0.0246	0.0239	0.0233	0.022		
Sine wave Single Side Cooled	0.0509	0.0482	0.0471	0.0463	0.044		

Form Factors							
Conduction Angle	30°	60°	90°	120°	180°	270°	d.c.
Square wave	3.46	2.45	2	1.73	1.41	1.15	1
Sine wave	3.98	2.78	2.22	1.88	1.57		

5.2 Calculating V_T using ABCD Coefficients

The on-state characteristic I_T vs. V_T, on page 7 is represented in two ways;

- (i) the well established V_o and r_s tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_T in terms of I_T given below:

$$V_T = A + B \cdot \ln(I_T) + C \cdot I_T + D \cdot \sqrt{I_T}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for V_T agree with the true device characteristic over a current range, which is limited to that plotted.

25°C Coefficients			125°C Coefficients
Α	0.9991763	Α	0.3604009
В	-0.04173358	В	0.079552
С	8.96106×10 ⁻⁵	С	2.23×10 ⁻⁴
D	0.01326142	D	1.92×10 ⁻³

5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}}\right)$$

Where p = 1 to n, n is the number of terms in the series and:

t = Duration of heating pulse in seconds.

 r_{+} = Thermal resistance at time t.

 r_p = Amplitude of p_{th} term.

 τ_{p} = Time Constant of r_{th} term.

	D.C. Double Side Cooled							
Term	Term 1 2 4 5							
r_p	3.424745×10 ⁻³	1.745273×10 ⁻³	8.532017×10 ⁻⁴	3.457329×10 ⁻⁴				
$ au_p$	1.125391	0.1878348	0.02788979	8.430889×10 ⁻³				

D.C. Single Side Cooled							
Term	Term 1 2 5 6						
r_p	8.375269×10 ⁻³	2.518437×10 ⁻³	1.193758×10 ⁻³	7.45432×10 ⁻⁴			
$ au_{p}$	8.929845	0.4711304	0.08221244	0.01221961			

6.0 Reverse recovery ratings

- (i) Q_{ra} is based on 50% I_{rm} chord as shown in Fig. 1.
- (ii) Q_{rr} is based on a 150μs integration time.

i.e.
$$Q_{rr} = \int_{0}^{150 \mu s} i_{rr}.dt$$

$$K \ Factor = \frac{t1}{t2}$$

(iii)
$$K Factor = \frac{t1}{t2}$$

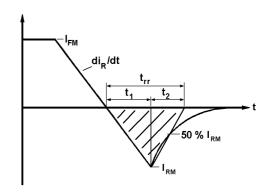


Fig. 1

Curves

Figure 1 - On-state characteristics of Limit device

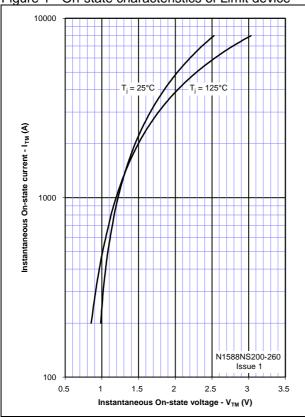


Figure 2 - Transient Thermal Impedance

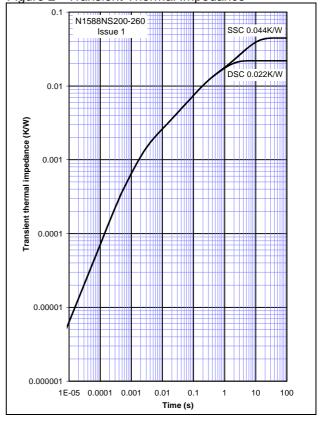


Figure 3 - Gate Characteristics - Trigger Limits

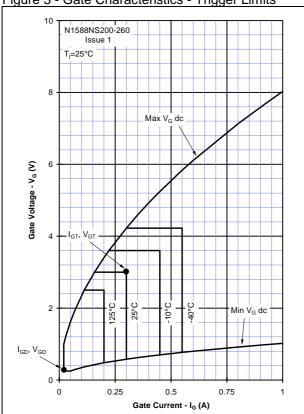
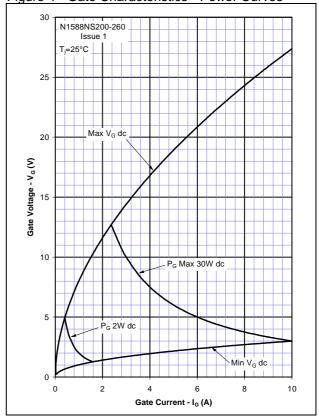
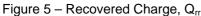


Figure 4 - Gate Characteristics - Power Curves





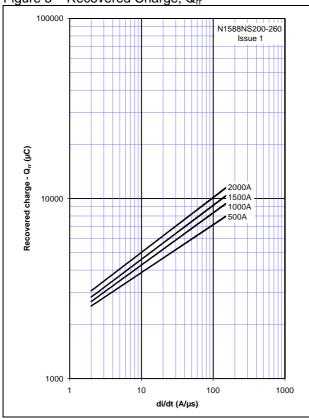
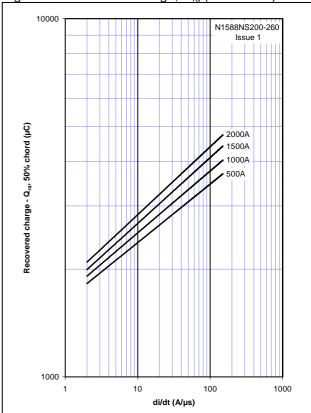


Figure 6 – Recovered charge, Q_{ra} (50% chord)



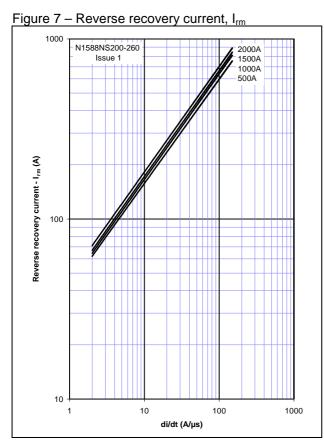


Figure 8 – Reverse recovery time, t_{rr}

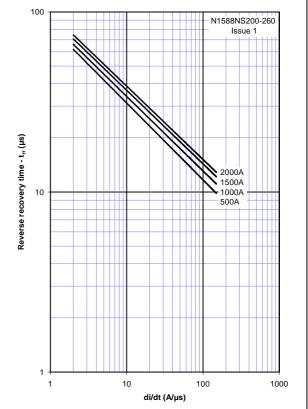


Figure 9 – On-state current vs. Power dissipation – Double Side Cooled (Sine wave)

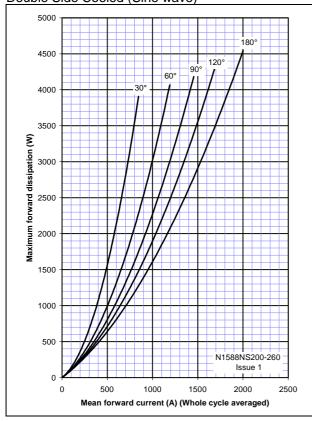


Figure 10 – On-state current vs. Heatsink temperature - Double Side Cooled (Sine wave)

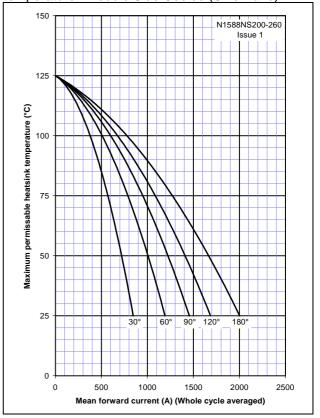


Figure 11 – On-state current vs. Power dissipation – Double Side Cooled (Square wave)

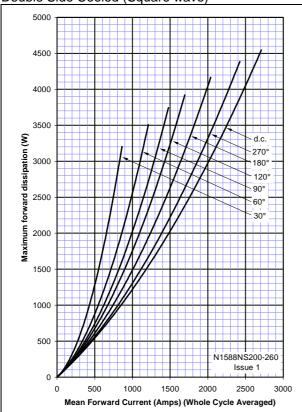


Figure 12 – On-state current vs. Heatsink temperature - Double Side Cooled (Square wave)

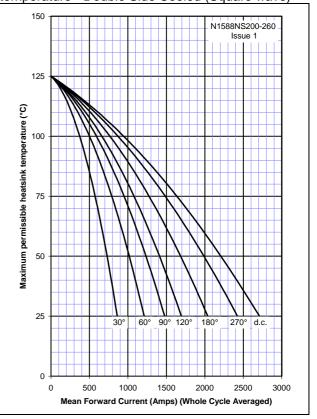


Figure 13 – On-state current vs. Power dissipation – Single Side Cooled (Sine wave)

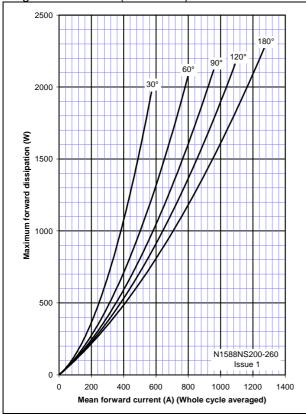


Figure 14 – On-state current vs. Heatsink temperature - Single Side Cooled (Sine wave)

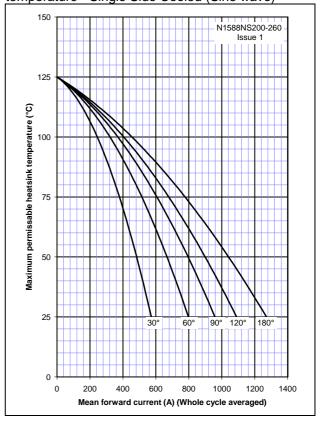


Figure 15 – On-state current vs. Power dissipation – Single Side Cooled (Square wave)

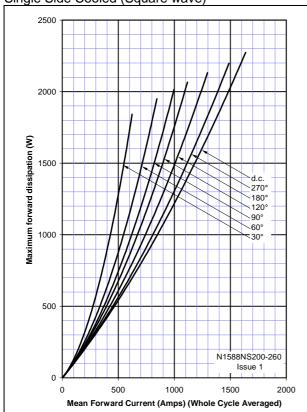
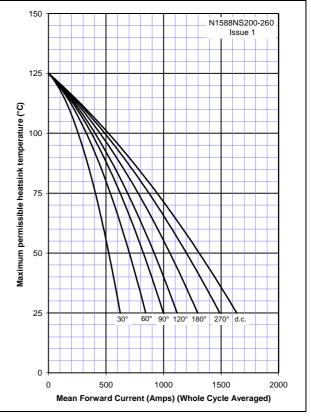
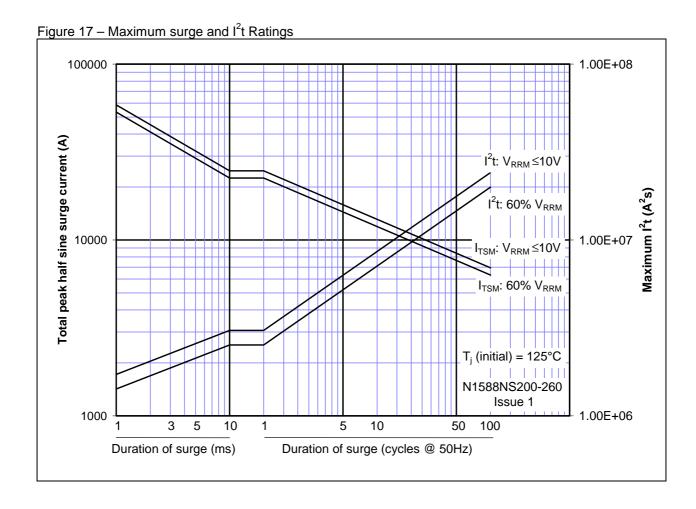
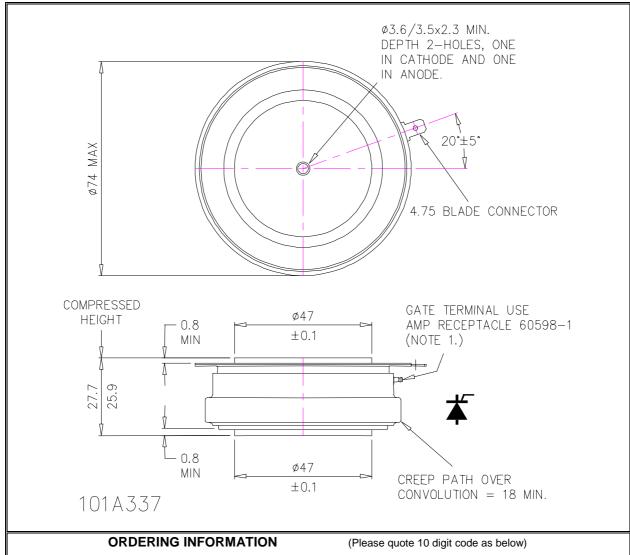


Figure 16 – On-state current vs. Heatsink temperature - Single Side Cooled (Square wave)





Outline Drawing & Ordering Information



N1588	NS	* *	0
Fixed	Fixed	Voltage Code	Fixed turn-off
Type Code	Outline Code	20-26	time code

 $Typical\ order\ code:\ N1588NS220-2200V\ V_{DRM},\ V_{RRM},\ 1000V/\mu s\ dv/dt,\ 27mm\ clamp\ height\ capsule.$

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